# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Young Ok HONG	06/25/2007
Dong Hwan LEE	06/25/2007

## **RECEIVING PARTY DATA**

Name:	Hynix Semiconductor Inc.	
Street Address:	San 136-1, Ami-ri, Bubal-eub	
City:	Icheon-si, Kyoungki-do	
State/Country:	KOREA, REPUBLIC OF	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11771214

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 123034-0007

NAME OF SUBMITTER: Yoon S. Ham

Total Attachments: 1

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**PATENT REEL: 019499 FRAME: 0051** 

500306238

Docket No.:

## ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Young Ok HONG
- 2) Dong Hwan LEE

3)

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

Hynix Semiconductor Inc. having a place of business at San 136-1, Ami-ri, Bubal-eub, Icheon-si,

# Kyoungki-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

# METAL LINE OF SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE SAME

(a)	for which an application for United States Letters Patent was file identified by United States Patent Application No.	d on, and
(b)	for which an application for United States Letters Patent was exe	cuted on,
all Unit	undersigned hereby authorizes and requests the United States Co ed States Letters Patent which may be granted therefore and any ations-in-part thereof, and the right to all benefits under the In y to the said ASSIGNEE, for its interest as ASSIGNEE, its succe hat the attorneys of record in said application shall hereafter act on	and all extensions, divisions, reissues, continuations, or ternational Convention for the Protection of Industrial ssors, assigns and legal representatives; the undersigned
ASSIGN applicat ASSIGN	AND the undersigned hereby agrees to transfer a like interestion for and obtaining original, divisional, reissued or extended Let NEE, its successors, assigns and legal representatives, and without ions for patent based thereon, growing out of or related to the NEE, its successors, assigns and legal representatives, deemed essention hereby transferred.	ters Patent of the United States, upon request of the said further remuneration, in and to any improvements, and said invention; and to execute any papers by the said
SIGNE	O on the date indicated aside my signature:	
1) Name	Young OK Hong Young Ok HONG	2007, 6, 2 <del>t</del> Date:  2007, 6, 25  Date:
2) Name	Dong Hwan LEE  Dong Hwan LEE	2007, 6, 25 Date:
3)	<del>-</del>	Date:

PATENT REEL: 019499 FRAME: 0052

RECORDED: 06/29/2007